PS11015

FLAT-BASE TYPE
INSULATED TYPE

PS11015

INTEGRATED FUNCTIONS AND FEATURES

- Converter bridge for 3 phase AC-to-DC power conversion.
- Circuit for dynamic braking of motor regenerative energy.
- 3-phase IGBT inverter bridge configured by the latest 3rd. generation IGBT and diode technology.
- Inverter output current capability I_O (Note 1):

Type Name	100% load	150% over load
PS11015	7.0A (rms)	10.5A (rms), 1min

(Note 1) : The inverter output current is assumed to be sinusoidal and the peak current value of each of the above loading cases is defined as : $I_{OP} = I_O \times \sqrt{2}$
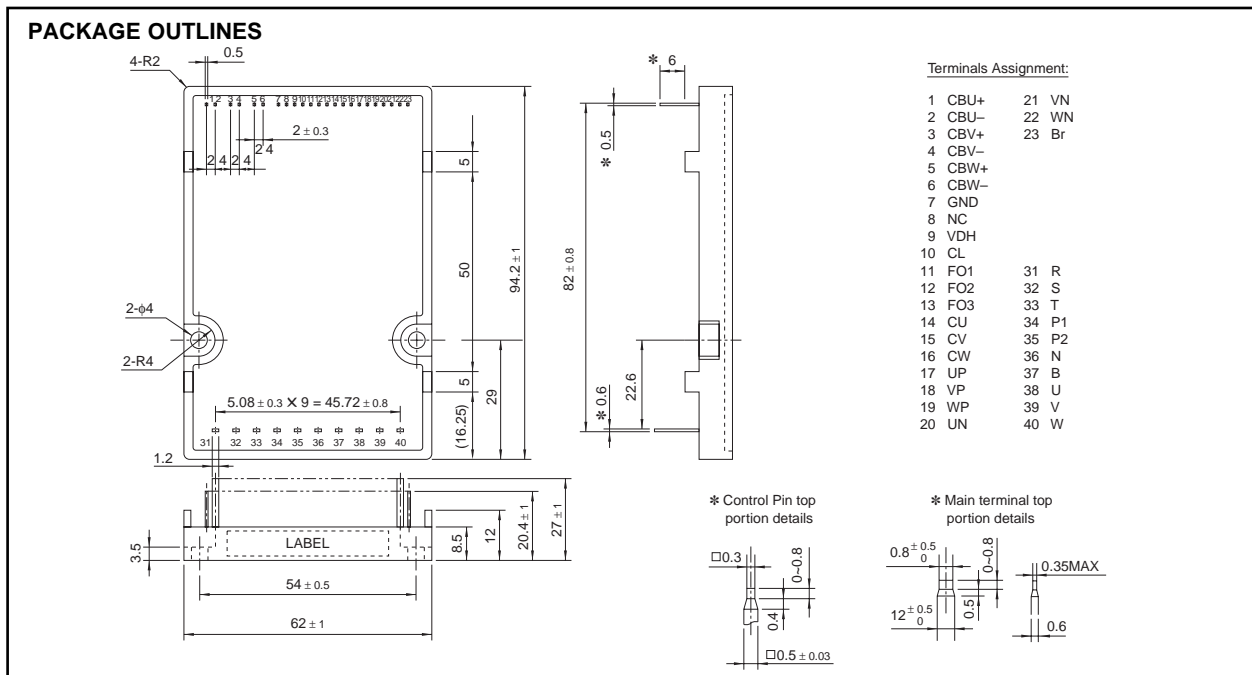
INTEGRATED DRIVE, PROTECTION AND SYSTEM CONTROL FUNCTIONS:

- For inverter side upper-leg IGBTs : Drive circuit, High voltage isolated high-speed level shifting, Short circuit protection (SC). Bootstrap circuit supply scheme (single drive power supply) and Under voltage protection (UV).
- For inverter side lower-leg IGBTs : Drive circuit, Short circuit protection (SC). Control supply circuit under- & over- voltage protection (OV/UV). System over temperature protection (OT). Fault output signaling circuit (FO) and Current limit warning signal output (CL).
- For Brake circuit IGBT : Drive circuit
- Warning and Fault signaling :
    - F_{O1} : Short circuit protection for lower-leg IGBTs and Input interlocking against spurious arm shoot-through.
    - F_{O2} : N-side control supply abnormality locking (OV/UV).
    - F_{O3} : System over-temperature protection (OT).
    - CL : Warning for inverter current overload condition
- For system feedback control : Analogue signal feedback reproducing actual inverter output phase currents (3φ).
- Input Interface : 5V CMOS/TTL compatible, Schmitt trigger input, and Arm-Shoot-Through interlock protection.
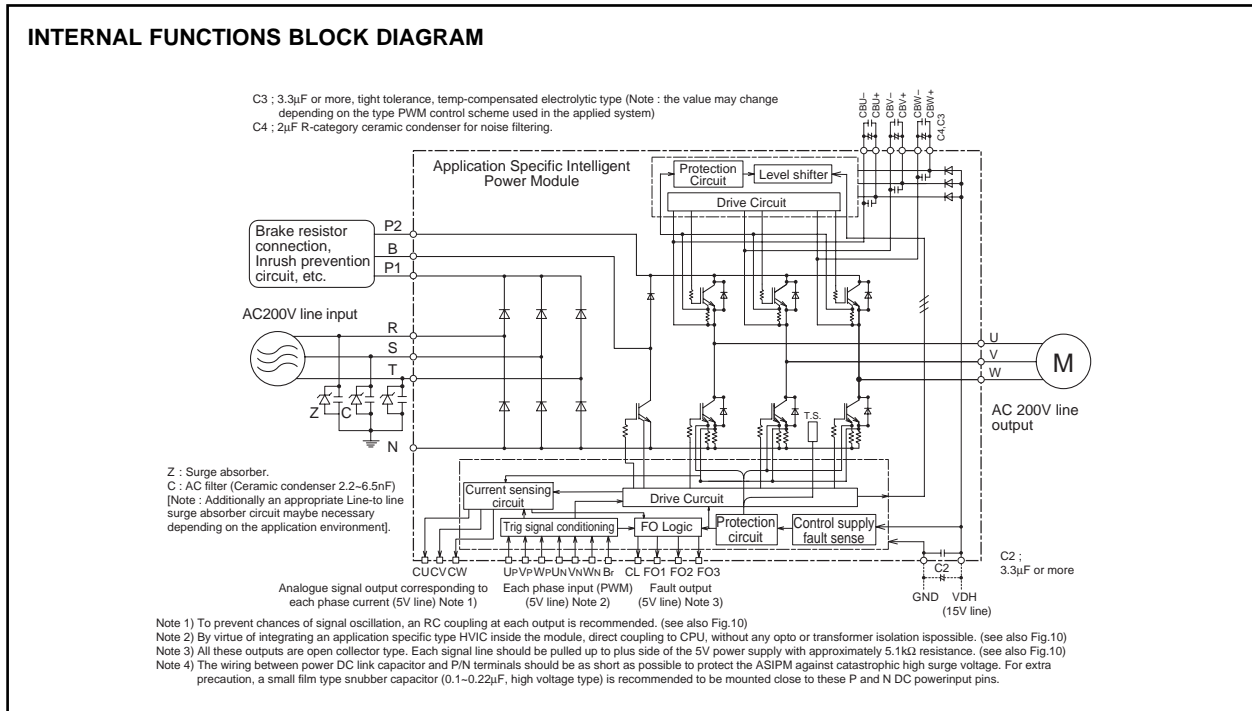
APPLICATION

Acoustic noise-less 1.5kW/AC200V class 3 phase inverter and other motor control applications

PACKAGE OUTLINES

Terminals Assignment:

1	CBU+	21	VN
2	CBU–	22	WN
3	CBV+	23	Br
4	CBV–		
5	CBW+		
6	CBW–		
7	GND		
8	NC		
9	VDH		
10	CL		
11	FO1	31	R
12	FO2	32	S
13	FO3	33	T
14	CU	34	P1
15	CV	35	P2
16	CW	36	N
17	UP	37	B
18	VP	38	U
19	WP	39	V
20	UN	40	W

∗ Control Pin top portion details

∗ Main terminal top portion details

(Fig. 1)

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INTERNAL FUNCTIONS BLOCK DIAGRAM

C3 ; 3.3µF or more, tight tolerance, temp-compensated electrolytic type (Note : the value may change depending on the type PWM control scheme used in the applied system)
C4 ; 2µF R-category ceramic condenser for noise filtering.

Z : Surge absorber.
C : AC filter (Ceramic condenser 2.2~6.5nF)
[Note : Additionally an appropriate Line-to line surge absorber circuit maybe necessary depending on the application environment].

C2 ; 3.3µF or more

Analogue signal output corresponding to each phase current (5V line) Note 1)
Each phase input (PWM) (5V line) Note 2)
Fault output (5V line) Note 3)

Note 1) To prevent chances of signal oscillation, an RC coupling at each output is recommended. (see also Fig.10)
Note 2) By virtue of integrating an application specific type HVIC inside the module, direct coupling to CPU, without any opto or transformer isolation ispossible. (see also Fig.10)
Note 3) All these outputs are open collector type. Each signal line should be pulled up to plus side of the 5V power supply with approximately 5.1kΩ resistance. (see also Fig.10)
Note 4) The wiring between power DC link capacitor and P/N terminals should be as short as possible to protect the ASIPM against catastrophic high surge voltage. For extra precaution, a small film type snubber capacitor (0.1~0.22µF, high voltage type) is recommended to be mounted close to these P and N DC powerinput pins.

(Fig. 2)

MAXIMUM RATINGS $(T_j = 25°C)$

INVERTER PART (Including Brake Part)

Symbol	Item	Condition	Ratings	Unit
V_{CC}	Supply voltage	Applied between P2-N	450	V
$V_{CC(surge)}$	Supply voltage (surge)	Applied between P2-N, Surge-value	500	V
V_P or V_N	Each output IGBT collector-emitter static voltage	Applied between P-U, V, W, Br or U, V, W, Br-N	600	V
$V_{P(S)}$ or $V_{N(S)}$	Each output IGBT collector-emitter switching surge voltage	Applied between P-U, V, W, Br or U, V, W, Br-N	600	V
$\pm I_C(\pm I_{CP})$	Each output IGBT collector current	$T_C = 25°C$	$\pm20\ (\pm40)$	A
$I_C(I_{CP})$	Brake IGBT collector current	Note: "( )" means I_C peak value	8 (16)	A
$I_F(I_{FP})$	Brake diode anode current		8 (16)	A

CONVERTER PART

Symbol	Item	Condition	Ratings	Unit
V_{RRM}	Repetitive peak reverse voltage		800	V
Ea	Recommended AC input voltage		220	V
I_O	DC output current	3ϕ rectifying circuit	25	A
I_{FSM}	Surge (non-repetitive) forward current	1 cycle at 60Hz, peak value non-repetitive	196	A
I^2t	I^2t for fusing	Value for one cycle of surge current	160	A^2s

CONTROL PART

Symbol	Item	Condition	Ratings	Unit
V_{DH}, V_{DB}	Supply voltage	Applied between V_{DH}-GND, $C_{BU}+$-$C_{BU}-$, $C_{BV}+$-$C_{BV}-$, $C_{BW}+$-$C_{BW}-$	20	V
V_{CIN}	Input signal voltage	Applied between $U_P \cdot V_P \cdot W_P \cdot U_N \cdot V_N \cdot W_N \cdot B_r$-GND	$-0.5 \sim 7.5$	V
V_{FO}	Fault output supply voltage	Applied between $F_{O1} \cdot F_{O2} \cdot F_{O3}$-GND	$-0.5 \sim 7$	V
I_{FO}	Fault output current	Sink current of $F_{O1} \cdot F_{O2} \cdot F_{O3}$	15	mA
V_{CL}	Current-limit warning (CL) output voltage	Applied between CL-GND	$-0.5 \sim 7$	V
I_{CL}	CL output current	Sink current of CL	15	mA
I_{CO}	Analogue current signal output current	Sink current of $CU \cdot CV \cdot CW$	±1	mA

PS11015

FLAT-BASE TYPE
INSULATED TYPE

TOTAL SYSTEM

Symbol	Item	Condition		Ratings	Unit
T_j	Junction temperature		(Note 2)	−20 ~ +125	°C
T_{stg}	Storage temperature	—		−40 ~ +125	°C
T_C	Module case operating temperature		(Fig. 3)	−20 ~ +100	°C
V_{iso}	Isolation voltage	60 Hz sinusoidal AC applied between all terminals and the base plate for 1 minute.		2500	Vrms
—	Mounting torque	Mounting screw: M3.5		0.78 ~ 1.27	kg·cm

Note 2) The item defines the maximum junction temperature for the power elements (IGBT/Diode) of the ASIPM to ensure safe operation. However, these power elements can endure junction temperature as high as 150°C instantaneously . To make use of this additional temperature allowance, a detailed study of the exact application conditions is required and, accordingly, necessary information is requested to be provided before use.

CASE TEMPERATURE MEASUREMENT POINT (3mm from the base surface)
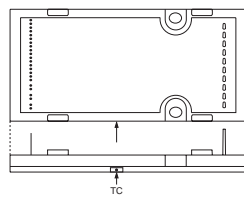
(Fig. 3)

THERMAL RESISTANCE

Symbol	Item	Condition	Ratings			Unit
			Min.	Typ.	Max.	
$R_{th(j-c)}$		Inverter IGBT (1/6)	—	—	2.9	°C/W
$R_{th(j-c)F}$		Inverter FWDi (1/6)	—	—	3.1	°C/W
$R_{th(j-c)QB}$	Junction to case Thermal Resistance	Brake IGBT	—	—	4.0	°C/W
$R_{th(j-c)FB}$		Brake FWDi	—	—	6.0	°C/W
$R_{th(j-c)FR}$		Converter Di (1/6)	—	—	4.3	°C/W
$R_{th(c-f)}$	Contact Thermal Resistance	Case to fin, thermal grease applied (1 Module)	—	—	0.044	°C/W

ELECTRICAL CHARACTERISTICS (T_j = 25°C, V_{DH} = 15V, V_{DB} = 15V unless otherwise noted)

Symbol	Item	Condition	Ratings			Unit
			Min.	Typ.	Max.	
$V_{CE(sat)}$	Collector-emitter saturation voltage	V_{DH} = V_{DB} = 15V, Input = ON, T_j = 25°C, I_C = 20A	—	—	2.9	V
V_{EC}	FWDi forward voltage	T_j = 25°C, I_C = −20A, Input = OFF	—	—	2.9	V
$V_{CE(sat)Br}$	Brake IGBT Collector-emitter saturation voltage	V_{DH} = 15V, Input = ON, T_j = 25°C, I_C = 8A	—	—	3.5	V
V_{FBr}	Brake diode forward voltage	T_j = 25°C, I_F = 8A, Input = OFF	—	—	2.9	V
I_{RRM}	Converter diode reverse current	V_R = V_{RRM}, T_j = 125°C	—	—	8	mA
V_{FR}	Converter diode voltage	T_j = 25°C, I_F = 10A	—	—	1.5	V
ton	Switching times	1/2 Bridge inductive load, Input = ON	0.3	0.6	1.5	µs
tc(on)		V_{CC} = 300V, I_C = 20A, T_j = 125°C	—	0.2	0.6	µs
toff		V_{DH} = 15V, V_{DB} = 15V	—	1.1	1.8	µs
tc(off)		Note : ton, toff include delay time of the internal control circuit	—	0.4	1.0	µs
trr	FWD reverse recovery time		—	0.1	—	µs
	Short circuit endurance (Output, Arm, and Load, Short Circuit Modes)	V_{CC} ≤ 400V, Input = ON (one-shot) T_j = 125°C start 13.5V ≤ V_{DH} = V_{DB} ≤ 16.5V	• No destruction • Fo output by protection operation			
	Switching SOA	V_{CC} ≤ 400V, T_j ≤ 125°C, I_C < $I_{OL(CL)}$ operation level, Input = ON 13.5V ≤ V_{DH} = V_{DB} ≤ 16.5V	• No destruction • No protecting operation • No Fo output			

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PS11015

FLAT-BASE TYPE
INSULATED TYPE

ELECTRICAL CHARACTERISTICS (Tj = 25°C, VDH = 15V, VDB = 15V unless otherwise noted)

Symbol	Item	Condition		Min.	Typ.	Max.	Unit
IDH	Circuit current	VDH = 15V, VCIN = 5V		—	—	150	mA
Vth(on)	Input on threshold voltage			0.8	1.4	2.0	V
Vth(off)	Input off threshold voltage			2.5	3.0	4.0	V
Ri	Input pull-up resistor	Integrated between input terminal-VDH		—	150	—	kΩ
fPWM	PWM input frequency	TC ≤ 100°C, Tj ≤ 125°C		2	—	20	kHz
txx	Allowable input on-pulse width	VDH = 15V, TC = −20°C ~ +100°C (Note 3)		1	—	500	µs
tdead	Allowable input signal dead time for blocking arm shoot-through	Relates to corresponding input (Except brake part) TC = −20°C ~ +100°C		2.2	—	—	µs
tint	Input inter-lock sensing	Relates to corresponding input (Except brake part)		—	65	100	ns
VCO	Analogue signal linearity with output current	Ic = 0A	VDH = 15V	1.87	2.27	2.57	V
VC+(200%)		Ic = IOP(200%)	TC = −20°C ~ +100°C	0.77	1.17	1.47	V
VC−(200%)		Ic = −IOP(200%)	(Fig. 4)	2.97	3.37	3.67	V
|ΔVCO|	Offset change area vs temperature	VDH = 15V, TC = −20°C ~ +100°C		—	15	—	mV
VC+	Analogue signal output voltage limit	Ic > IOP(200%), VDH = 15V		—	—	0.7	V
VC−		(Fig. 4)		4.0	—	—	V
ΔVC(200%)	Analogue signal over all linear variation	|VCO-VC±(200%)|		—	1.1	—	V
rCH	Analogue signal data hold accuracy	Correspond to max. 500µs data hold period only, Ic = IOP(200%) (Fig. 5)		−5	—	5	%
td(read)	Analogue signal reading time	After input signal trigger point (Fig. 8)		—	3	—	µs
±IOL	Current limit warning (CL) operation level	VDH =15V, TC = −20°C ~ +100°C (Note 4)		20.35	24.70	29.00	A
ICL(H)	Signal output current of CL operation — Idle	Open collector output		—	—	1	µA
ICL(L)	Signal output current of CL operation — Active			—	1	—	mA
SC	Short circuit over current trip level	Tj = 25°C (Fig. 7) (Note 5)		30.0	53.0	76.0	A
OT	Over temperature protection — Trip level	VDH = 15V		110	115	120	°C
OTr	Over temperature protection — Reset level			—	96	—	°C
UVDH	Supply circuit under & over voltage protection — Trip level			11.05	12.00	12.75	V
UVDHr	Supply circuit under & over voltage protection — Reset level			11.55	12.50	13.25	V
OVDH	Supply circuit under & over voltage protection — Trip level	TC = −20°C ~ +100°C		18.00	19.20	20.15	V
OVDHr	Supply circuit under & over voltage protection — Reset level	Tj ≤ 125°C		16.50	17.50	18.65	V
UVDB	Supply circuit under & over voltage protection — Trip level			10.0	11.0	12.0	V
UVDBr	Supply circuit under & over voltage protection — Reset level			10.5	11.5	12.5	V
tdV	Filter time			—	10	—	µs
IFO(H)	Fault output current — Idle	Open collector output		—	—	1	µA
IFO(L)	Fault output current — Active			—	1	—	mA

(Note 3) : (a) Allowable minimum input on-pulse width : This item applies to P-side circuit only.
(b) Allowable maximum input on-pulse width : This item applies to both P-side and N-side circuits excluding the brake circuit.

(Note4) : CL output : The "current limit warning (CL) operation circuit outputs warning signal whenever the arm current exceeds this limit. The circuit is reset automatically by the next input signal and thus, it operates on a pulse-by-pulse scheme.

(Note5) : The short circuit protection works instantaneously when a high short circuit current flows through an internal IGBT rising up momentarily. The protection function is, thus meant primarily to protect the ASIPM against short circuit distraction. Therefore, this function is not recommended to be used for any system load current regulation or any over load control as this might, cause a failure due to excessive temperature rise. Instead, the analogue current output feature or the over load warning feature (CL) should be appropriately used for such current regulation or over load control operation. In other words, the PWM signals to the ASIPM should be shut down, in principle, and not to be restarted before the junction temperature would recover to normal, as soon as a fault is feed back from its FO1 pin of the ASIPM indicating a short circuit situation.

RECOMMENDED CONDITIONS

Symbol	Item	Condition	Ratings	Unit
VCC	Supply voltage	Applied across P2-N terminals	400 (max.)	V
VDH, VDB	Control supply voltage	Applied between VDH-GND, CBU+-CBU−, CBV+-CBV−, CBW+-CBW−	15±1.5	V
ΔVDH, ΔVDB	Supply voltage ripple		±1 (max.)	V/µs
VCIN(on)	Input on voltage		0 ~ 0.3	V
VCIN(off)	Input off voltage		4.8 ~ 5.0	V
fPWM	PWM Input frequency	Using application circuit	2 ~ 20	kHz
tdead	Arm shoot-through blocking time	Using application circuit	2.2 (min.)	µs

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Fig. 4 OUTPUT CURRENT ANALOGUE SIGNALING LINEARITY

Real load current peak value.(%)(Ic=Io×√2)

(Fig. 4)
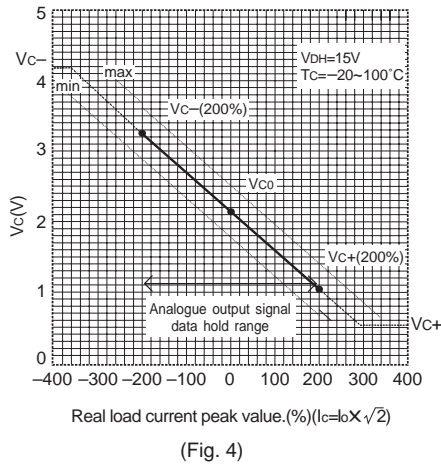
Fig. 5 OUTPUT CURRENT ANALOGUE SIGNALING "DATA HOLD" DEFINITION

$$rCH= \frac{VCH(505\mu s)-VCH(5\mu s)}{VCH(5\mu s)}$$
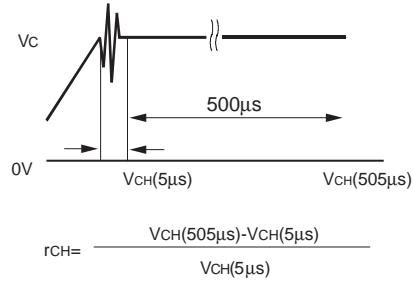
Note ; Ringing happens around the point where the signal output voltage changes state from "analogue" to "data hold" due to test circuit arrangement and instrumentational trouble. Therefore, the rate of change is measured at a 5 μs delayed point.
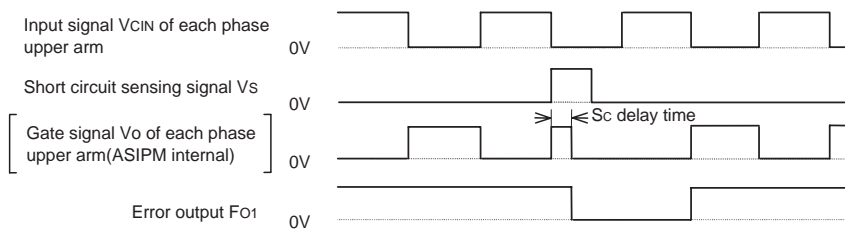
Fig. 6 INPUT INTERLOCK OPERATION TIMING CHART

Input signal $V_{CIN(p)}$ of each phase upper arm

Input signal $V_{CIN(n)}$ of each phase lower arm

Gate signal $V_{o(p)}$ of each phase upper arm (ASIPM internal)

Gate signal $V_{o(n)}$ of each phase upper arm (ASIPM internal)

Error output F_{O1}
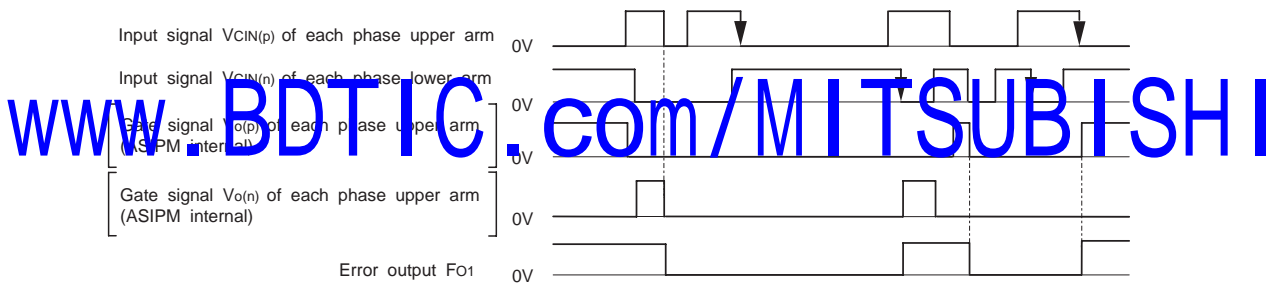
Note : Input interlock protection circuit ; It is operated when the input signals for any upper-arm / lower-arm pair of a phase are simultaneously in "LOW" level.

By this interlocking, both upper and lower IGBTs of this mal-triggered phase are cut off, and "Fo" signal is outputted. After an "input interlock" operation the circuit is latched. The "Fo" is reset by the high-to-low going edge of either an upper-leg, or a lower-leg input, whichever comes in later.

Fig. 7 TIMING CHART AND SHORT CIRCUIT PROTECTION OPERATION

Input signal V_{CIN} of each phase upper arm

Short circuit sensing signal V_S

Gate signal V_o of each phase upper arm(ASIPM internal)

Error output F_{O1}

Note : Short circuit protection operation. The protection operates with "Fo" flag and reset on a pulse-by-pulse scheme. The protection by gate shutdown is given only to the IGBT that senses an overload (excluding the IGBT for the "Brake").

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Fig. 8 INVERTER OUTPUT ANALOGUE CURRENT SENSING AND SIGNALING TIMING CHART
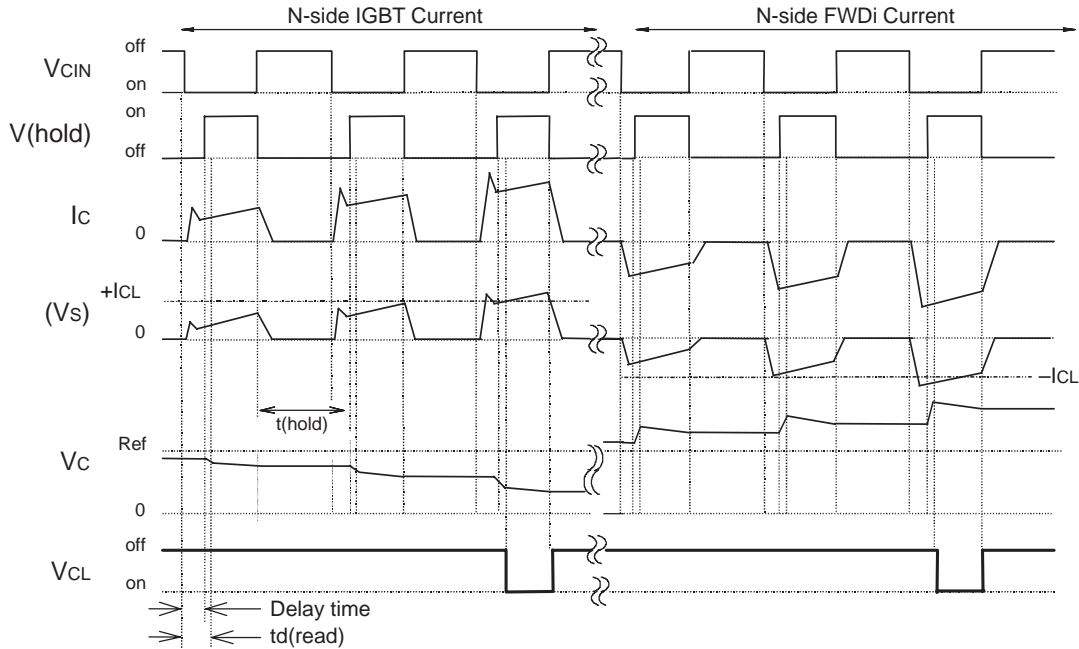
Fig. 9 START-UP SEQUENCE

Normally at start-up, Fo and CL output signals will be pulled-up High to Supply voltage (OFF level); however, F$_{O1}$ output may fall to Low (ON) level at the instant of the first ON input pulse to an N-Side IGBT. This can happen particularly when the boot-strap capacitor is of large size. F$_{O1}$ resetting sequence (together with the boot-strap charging sequence) is explained in the following graph

Fig. 10 RECOMMENDED I/O INTERFACE CIRCUIT
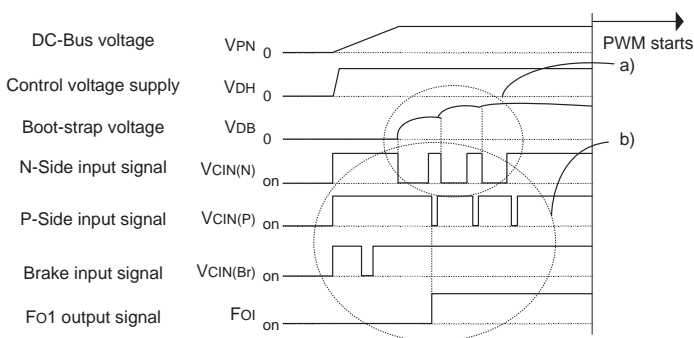
a) Boot-strap charging scheme :
Apply a train of short ON pulses at all N-IGBT input pins for adequate charging (pulse width = approx. 20μs number of pulses =10 ~ 500 depending on the boot-strap capacitor size)

b) F$_{O1}$ resetting sequence:
Apply ON signals to the following input pins : Br → Un/Vn/Wn → Up/Vp/Wp in that order.

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